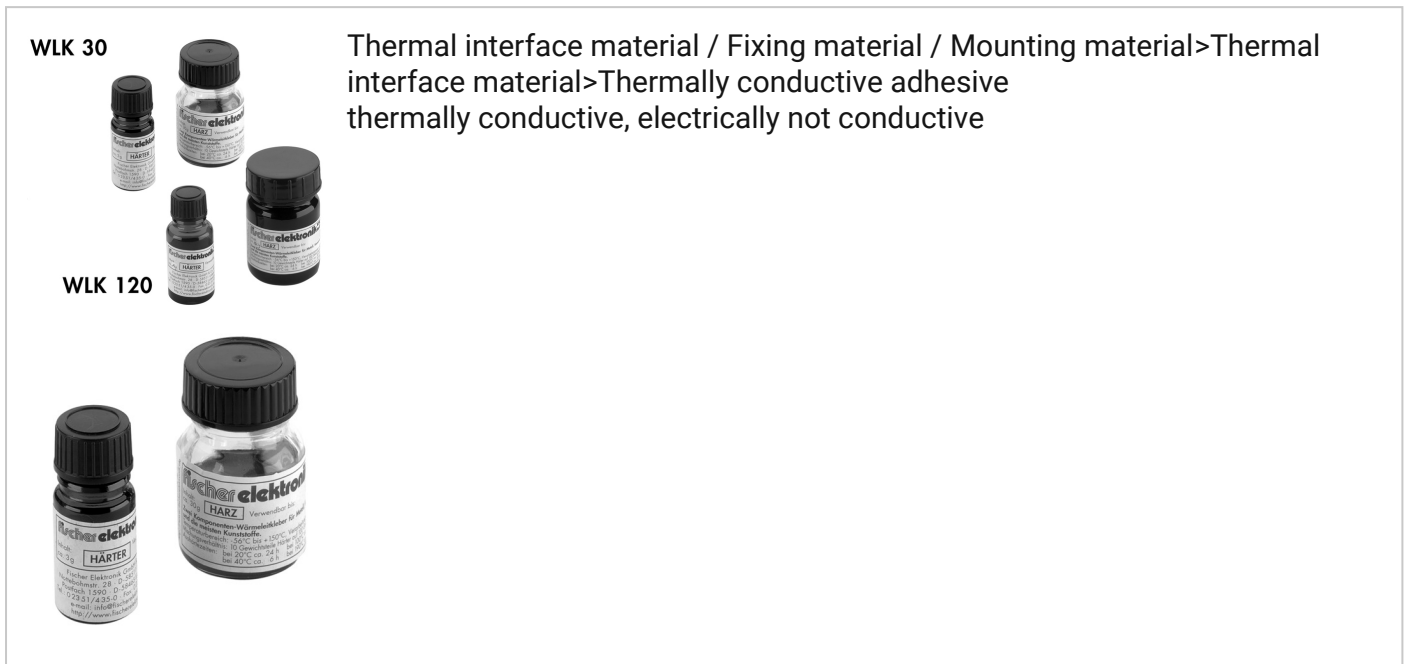


Data sheet Product WLK 30



Features

thermal conductivity:	0.836 W/m·K
specific thermal resistance:	1.2 m·K/W
hardening time:	20°C approx. 16-24h / 25°C approx. 8 h / 120°C approx. 20 min
volume resistance:	10 ¹⁶ Ω/cm
temperature range:	-56°C... +149°C
glue layer:	Epoxid
mixture proportion:	10:1
composition:	30 g resin/3 g hardener